

800V N-Channel Power MOSFET



TO-220

ITO-220



Pin Definition:

- 1. Gate
- Drain
 Source

Key Parameter Performance

Parameter	Value	Unit
V_{DS}	800	V
R _{DS(on)} (max)	1.05	Ω
Q_g	53	nC

Features

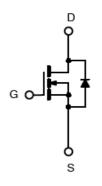
- Low R_{DS(ON)} 1.05Ω (Max.)
- Low gate charge typical @ 53nC (Typ.)
- Improve dv/dt capability

Ordering Information

Part No.	Package	Packing
TSM10N80CZ C0G	TO-220	50pcs / Tube
TSM10N80CI C0G	ITO-220	50pcs / Tube

Note: "G" denotes for Halogen- and Antimony-free as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds

Block Diagram



N-Channel MOSFET

Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V_{DS}	800	V	
Gate-Source Voltage	V_{GS}	±30	V	
Continuous Drain Current	I _D	9.5	А	
Pulsed Drain Current (Note 1)	I _{DM}	38	А	
Single Pulse Avalanche Energy (Note 2)	E _{AS}	267	mJ	
Peak Diode Recovery dv/dt (Note 3)	dv/dt	4.5	V	
Avalanche Current (Repetitive) (Note 4)	I _{AR}	9.5	А	
Repetitive Avalanche Energy (Note 4)	E _{AR}	29	mJ	
Operating Junction Temperature	TJ	150	°C	
Storage Temperature Range	T _{STG}	-55 to +150	°C	

Thermal Performance

Parameter		Symbol	Limit	Unit
Thermal Resistance - Junction to Case	TO-220	R _{eJC}	0.43	°C/W
	ITO-220		2.6	
Thermal Resistance - Junction to Ambient	TO-220 / ITO-220	$R_{\Theta JA}$	62.5	

Notes: Surface mounted on FR4 board t ≤ 10sec



800V N-Channel Power MOSFET



Electrical Specifications (T_J=25°C unless otherwise noted)

Parameter	Conditions	Symbol	Min	Тур	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV _{DSS}	800			V
Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 4.75A$	R _{DS(ON)}		0.9	1.05	Ω
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	V _{GS(TH)}	2.0		4.0	V
Zero Gate Voltage Drain Current	$V_{DS} = 800V, V_{GS} = 0V$	I _{DSS}			10	μA
Gate Body Leakage	$V_{GS} = \pm 30V, V_{DS} = 0V$	I _{GSS}			±100	nA
Forward Transconductance	$V_{DS} = 30V, I_{D} = 4.75A$	g _{fs}		6.3		S
Diode Forward Voltage	$I_S = 9.5A, V_{GS} = 0V$	V_{SD}			1.5	V
Dynamic (Note 6)						
Total Gate Charge	\/ C40\/ L 0.5A	Q_g		53		
Gate-Source Charge	$V_{DS} = 640V, I_{D} = 9.5A,$	Q_gs		10		nC
Gate-Drain Charge	$V_{GS} = 10V$	Q_{gd}		23		
Input Capacitance)/ OF)/)/ OV	C _{iss}		2336		
Output Capacitance	$V_{DS} = 25V$, $V_{GS} = 0V$,	C_{oss}		214		pF
Reverse Transfer Capacitance	f = 1.0MHz	C_{rss}		29		
Switching (Note 7)						
Turn-On Delay Time		t _{d(on)}		63		
Turn-On Rise Time	$V_{GS} = 10V, I_D = 9.5A,$ $V_{DD} = 400V, R_G = 25\Omega$	t _r		62		
Turn-Off Delay Time		t _{d(off)}		256		ns
Turn-Off Fall Time		t _f		72		
Reverse Recovery Time	$V_{GS} = 0V, I_S = 9.5A,$	t _{fr}		450		ns
Reverse Recovery Charge	$dI_F/dt = 100A/us$	Q_{fr}		5.3		μC

Notes:

- 1. Limited by maximum junction temperature
- 2. $V_{DD} = 50V$, $I_{AS}=10A$, L=5mH, $R_G=25\Omega$
- 3. $I_{SD} \le 9.5A$, $di/dt \le 200A/\mu s$, $V_{DD} \le BV$
- 4. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
- 5. Pulse test: pulse width ≤300µs, duty cycle ≤2%
- 6. For design reference only, not subject to production testing.
- 7. Switching time is essentially independent of operating temperature.

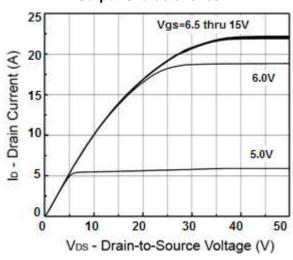


800V N-Channel Power MOSFET

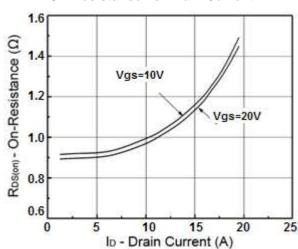


Electrical Characteristics Curves

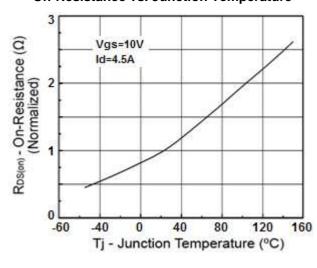
Output Characteristics



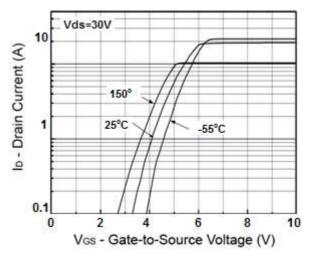
On-Resistance vs. Drain Current



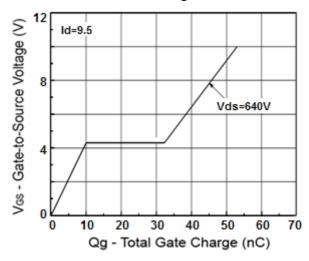
On-Resistance vs. Junction Temperature



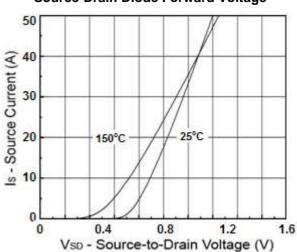
Transfer Characteristics



Gate Charge



Source-Drain Diode Forward Voltage



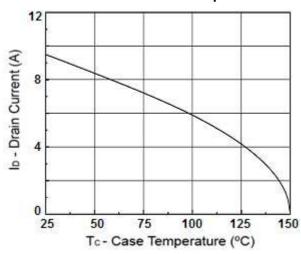


800V N-Channel Power MOSFET

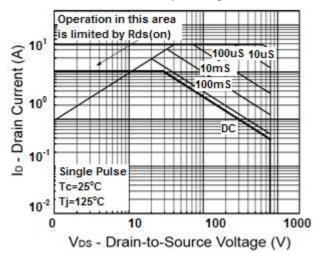


Electrical Characteristics Curves

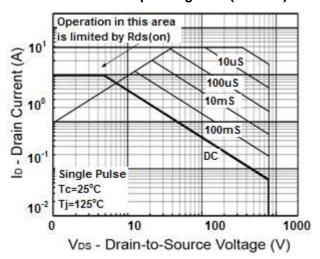
Drain Current vs. Case Temperature



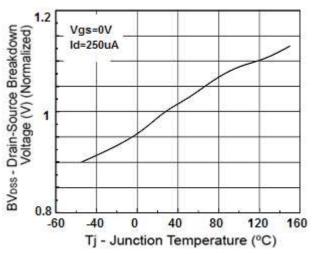
Maximum Safe Operating Area



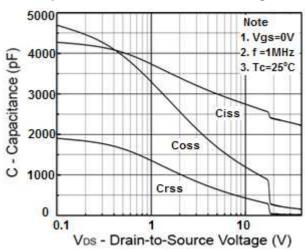
Maximum Safe Operating Area (ITO-220)



BV_{DSS} vs. Junction Temperature



Capacitance vs. Drain-Source Voltage



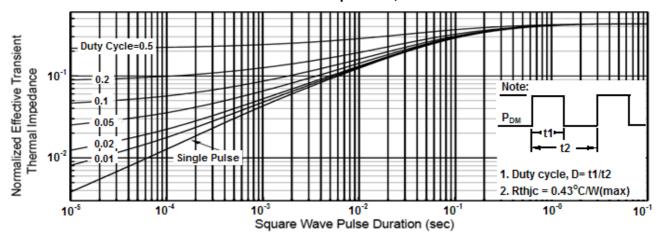


800V N-Channel Power MOSFET

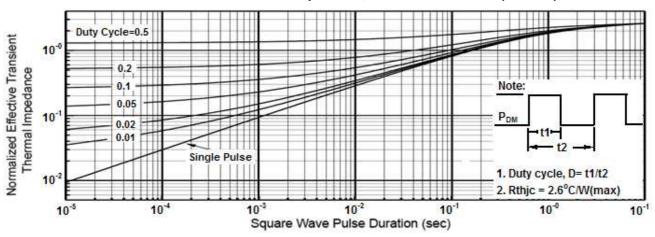


Electrical Characteristics Curves

Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient(ITO-220)

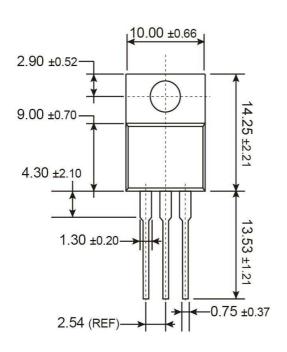


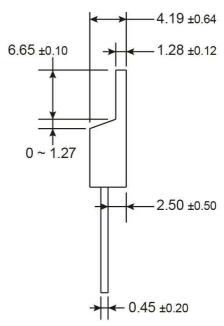






TO-220 Mechanical Drawing





Unit: Millimeters

Marking Diagram



G = Halogen Free

Y = Year Code

WW = Week Code (01~52)

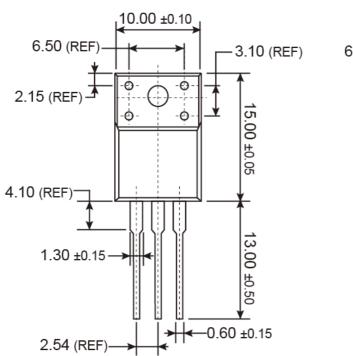
F = Factory Code

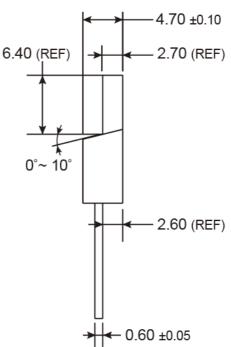


800V N-Channel Power MOSFET



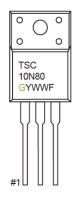
ITO-220 Mechanical Drawing





Unit: Millimeters

Marking Diagram



G = Halogen Free

Y = Year Code

WW = Week Code (01~52)

F = Factory Code



TSM10N80 800V N-Channel Power MOSFET

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Taiwan Semiconductor:

TSM10N80CI COG TSM10N80CZ CO